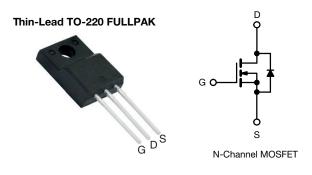
SiHA21N60EF

Vishay Siliconix

EF Series Power MOSFET with Fast Body Diode



www.vishay.com

PRODUCT SUMMARY						
V_{DS} (V) at T_J max.	650					
R _{DS(on)} max. (Ω) at 25 °C	V _{GS} = 10 V 0.176					
Q _g max. (nC)	84					
Q _{gs} (nC)	14					
Q _{gd} (nC)	24					
Configuration	Single					

FEATURES

- Fast body diode MOSFET using E series technology
- Reduced t_{rr}, Q_{rr}, and I_{RRM}
- Low figure-of-merit (FOM): Ron x Qg
- Low input capacitance (Ciss)
- Increased robustness due to low Q_{rr}
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Telecommunications
 - Server and telecom power supplies
- Lighting
 - High intensity discharge (HID)
 - Light emitting diodes (LEDs)
- Consumer and computing - ATX power supplies
- Industrial
 - Welding - Battery chargers
- Renewable energy
 - Solar (PV inverters)
- Switch mode power suppliers (SMPS)
- Applications using the following topologies
- LLC
- Phase shifted bridge (ZVS)
- 3-level inverter
- AC/DC bridge

ORDERING INFORMATION				
Package	Thin-Lead TO-220 FULLPAK			
Lead (Pb)-free	SiHA21N60EF-E3			
Lead (Pb)-free and halogen-free	SiHA21N60EF-GE3			

PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V _{DS}	600	- v
Gate-source voltage			V _{GS}	± 30	
Continuous drain current (T _J = 150 °C)	V at 10 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$	- I _D -	9	А
	V _{GS} at 10 V	T _C = 100 °C		5	
Pulsed drain current ^a			I _{DM}	53	
Linear derating factor				0.28	W/°C
Single pulse avalanche energy ^b			E _{AS}	367	mJ
Maximum power dissipation			PD	35	W
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C
Drain-source voltage slope	T _J = 125 °C		d\//dt	70	
Reverse diode dV/dt ^d			dV/dt	50	V/ns
Soldering recommendations (peak temperature) ^c	for 10 s			300	°C
Mounting torque M3 screw				0.6	Nm

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. $V_{DD} = 50$ V, starting $T_J = 25$ °C, L = 28.2 mH, $R_g = 25 \Omega$, $I_{AS} = 5.1$ A

1.6 mm from case c.

d. $I_{SD} \leq I_D$, dl/dt = 900 A/µs, starting T_J = 25 °C

S21-0257-Rev. F, 22-Mar-2021



1

HALOGEN FREE



THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum junction-to-ambient	R _{thJA}	-	65	°C/W	
Maximum junction-to-case (drain)	R _{thJC}	-	3.6		

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-source breakdown voltage	V _{DS}	V _{GS} :	= 0 V, I _D = 250 μA	600	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	Reference to 25 °C, $I_D = 1 \text{ mA}$		0.59	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$		-	4.0	V
Gate-source leakage	1	$V_{GS} = \pm 20 V$		-	-	± 100	nA
Gale-Source leakage	$V_{GSS} = \pm 30 \text{ V}$		$V_{GS} = \pm 30 V$	-	-	± 1	μA
Zero gate voltage drain current	Inco	$V_{DS} = 480 \text{ V}, V_{GS} = 0 \text{ V}$		-	-	1	μA
Zero gate voltage drain current	I _{DSS}	$V_{DS} = 480 V_{DS}$	∕, V _{GS} = 0 V, T _J = 125 °C	-	-	500	μΑ
Drain-source on-state resistance	R _{DS(on)}	$V_{GS} = 10 V$	I _D = 11 A	-	0.153	0.176	Ω
Forward transconductance	9 _{fs}	V _{DS}	= 30 V, I _D = 11 A	-	7	-	S
Dynamic							
Input capacitance	C _{iss}		$V_{GS} = 0 V,$	-	2030	-	-
Output capacitance	C _{oss}		V _{DS} = 100 V,	-	105	-	
Reverse transfer capacitance	C _{rss}		f = 1 MHz	-	5	-	
Effective output capacitance, energy related ^a	$C_{o(er)}$	$V_{\rm GS}$ = 0 V, $V_{\rm DS}$ = 0 V to 480 V		-	86	-	pF
Effective output capacitance, time related ^b	C _{o(tr)}			-	299	-	
Total gate charge	Qg		V _{GS} = 10 V I _D = 11 A, V _{DS} = 480 V		56	84	nC
Gate-source charge	Q _{gs}	$V_{GS} = 10 \text{ V}$			14	-	
Gate-drain charge	Q _{gd}				24	-	
Turn-on delay time	t _{d(on)}			-	21	42	
Rise time	t _r	V _{DD} = 480 V, I _D = 11 A		-	31	62	- ns
Turn-off delay time	t _{d(off)}	$R_g = 9$	$R_{g} = 9.1 \Omega, V_{GS} = 10 V$		59	89	
Fall time	t _f			-	27	54	1
Gate input resistance	Rg	f = 1 MHz, open drain		0.2	0.56	1.2	Ω
Drain-Source Body Diode Characteristic	s			•	•	•	
Continuous source-drain diode current	I _S	MOSFET syml showing the	MOSFET symbol		-	21	
Pulsed diode forward current	I _{SM}	integral reverse p - n junction diode		-	-	53	A
Diode forward voltage	V _{SD}	$T_J = 25 \text{ °C}, I_S = 11 \text{ A}, V_{GS} = 0 \text{ V}$		-	0.9	1.2	V
Reverse recovery time	t _{rr}		<u> </u>		135	270	ns
Reverse recovery charge	Q _{rr}	T _J = 25 °C, I _F = I _S = 11 A, dI/dt = 100 A/µs, V _R = 400 V		-	0.76	1.52	μC
Reverse recovery current	I _{RRM}			-	11	-	A

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS}

b. $C_{oss(tr)}$ is a fixed capacitance that gives the charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS}



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

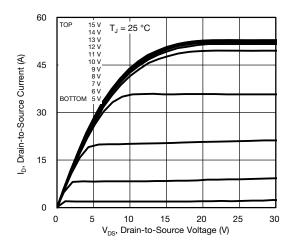


Fig. 1 - Typical Output Characteristics, T_J = 25 °C

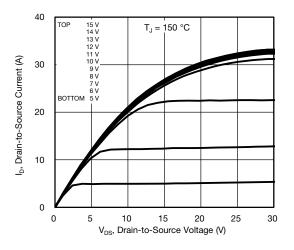


Fig. 2 - Typical Output Characteristics, T_J = 150 °C

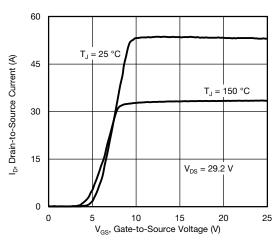


Fig. 3 - Typical Transfer Characteristics

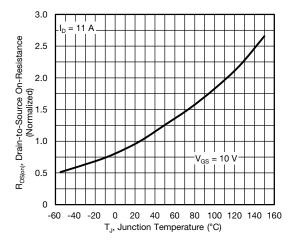


Fig. 4 - Normalized On-Resistance vs. Temperature

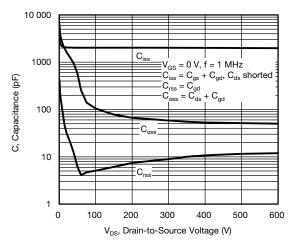


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

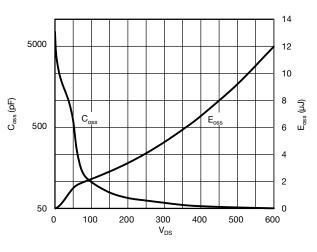


Fig. 6 - $C_{\rm oss}$ and $E_{\rm oss}$ vs. $V_{\rm DS}$

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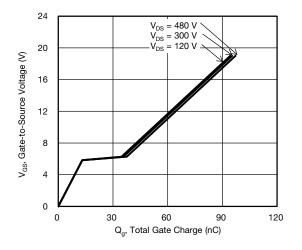


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

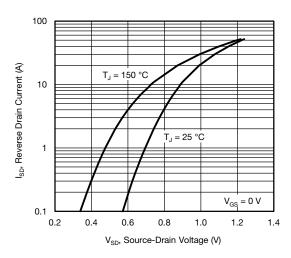


Fig. 8 - Typical Source-Drain Diode Forward Voltage

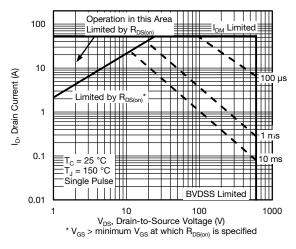


Fig. 9 - Maximum Safe Operating Area

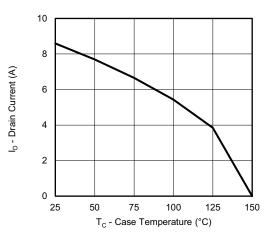


Fig. 10 - Maximum Drain Current vs. Case Temperature

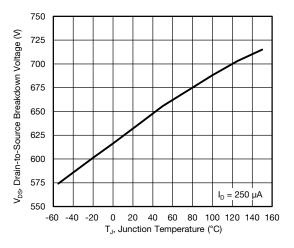


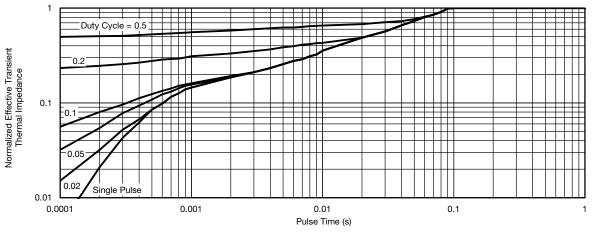
Fig. 11 - Typical Drain-to-Source Voltage vs. Temperature

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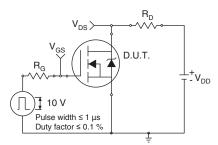


Fig. 13 - Switching Time Test Circuit

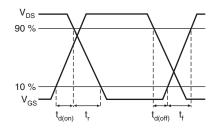


Fig. 14 - Switching Time Waveforms

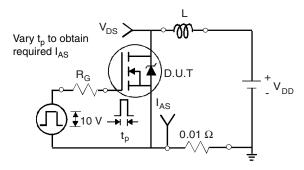


Fig. 15 - Unclamped Inductive Test Circuit

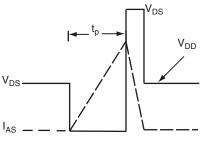


Fig. 16 - Unclamped Inductive Waveforms

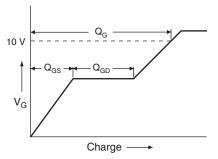


Fig. 17 - Basic Gate Charge Waveform

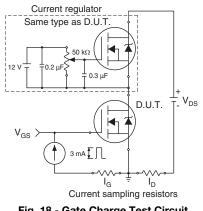


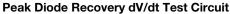
Fig. 18 - Gate Charge Test Circuit

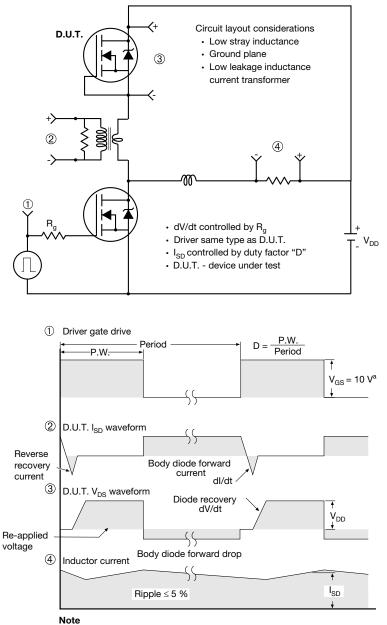
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a. $V_{GS} = 5 V$ for logic level devices

Fig. 19 - For N-Channel

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TO-220 FULLPAK Thin Lead





		DIMEN	ISIONS	
SYMBOL	MILLIN	METERS	INC	HES
	MIN.	MAX.	MIN.	MAX.
А	4.30	4.70	0.169	0.185
A1	2.50	2.90	0.098	0.114
A2	2.40	2.80	0.094	0.110
b	0.60	0.80	0.024	0.031
b2	0.60	0.90	0.024	0.035
С	-	0.60	-	0.024
D	8.30	8.70	0.327	0.342
d1	14.70	15.30	0.579	0.602
d2	2.90	3.10	0.114	0.122
d3	3.30	3.70	0.130	0.146
E	9.70	10.30	0.382	0.406
е	2.50	2.70	0.098	0.106
L	13.40	13.80	0.528	0.543
L1	1.00	2.80	0.039	0.110
ØP	3.00	3.40	0.118	0.134
ECN: E20-0684-Rev. D, 28 DWG: 6021	3-Dec-2020	·	·	



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